

ELECTRODE FORMING SYSTEM FOR CHIP COMPONENTS
ABSTRACT OF THE DISCLOSURE

An electrode forming system automatically carries out overall steps of charging chip components, coating electrode material on both ends of the components and discharging the components using a holding plate, a guide plate and a spacer. This system comprises a charger, a transferer, an electrode coater, a drying furnace, a holding plate standby means, a spacer storage means, a holding plate storage means, a discharger, a transport robot, conveyor means and a control unit. Movements of these apparatus are integratedly controlled by the control unit.

The robot transports the holding plate, the guide plate or the spacer among these apparatus arranged within its working area.

This Sheet Has Been Replaced

